



**PATENT**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

MICHAEL FRIEDEMANN  
VOLKER KAHLERT

Examiner: Lynne Ann Gurley

Group Art Unit: 2812

Serial No.: 10/602,484

Att'y Docket: 2000.106000/DE0247

Filed: June 24, 2003

Customer No.: 23720

For: METHOD OF FORMING A  
CONDUCTIVE BARRIER LAYER  
HAVING IMPROVED ADHESION AND  
RESISTIVITY CHARACTERISTICS

**RESPONSE TO OFFICE ACTION DATED JANUARY 22, 2004**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

CERTIFICATE OF MAILING  
37 C.F.R. 1.8

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date below:

March 10, 2004

Date

*Mary Paul*  
Signature

This paper is submitted in response to the Office Action dated January 22, 2004, for which the three-month date for response is April 22, 2004.

No fee is believed to be due in connection with the present paper. However, if any fees are required under 37 C.F.R. §§ 1.16 to 1.21, the Director is authorized to deduct such fees from Advanced Micro Devices, Inc. Deposit Account No. 01-0365/DE0247. In the event the monies in that account are insufficient, the Director is authorized to withdraw funds from Williams, Morgan & Amerson, P.C. Deposit Account No. 50-0786/2000.106000.

Reconsideration of the application in view of the following amendments and remarks is respectfully requested.